## CLAIM AMENDMENTS

## 1. (canceled)

- 3. (currently amended) The method according to claim [[1]] 20 wherein a target with aluminum as the doping agent is used.
- 4. (currently amended) The method according to claim [[1]]  $\underline{20}$  wherein the substrate is heated to temperatures above  $\underline{250}$  °C.
- 5. (currently amended) The method according to claim [[1]] 20 wherein a dynamic deposition rate of greater than 80 nm\*m/min is set that corresponds to a static deposition rate of greater than 300 nm/min.
- 6. (currently amended) The method according to claim
  [[1]] 20 wherein a dual magnetron arrangement with medium frequency
  excitation is used.

- 7. (currently amended) The method according to claim
  [[1]] 20 wherein a dynamic flow process is carried out in which the
  substrate is moved during sputtering.
- 8. (currently amended; withdrawn) A conductive and transparent zinc oxide layer, produced with the method according to claim [[1]] 20, characterized in that wherein the content of doping agent, particularly of aluminum, in the produced oxide layer is less than 3.5 at-%, [[that]] the resistivity is less than 1\*10<sup>-3</sup> W cm, [[that]] the charge carrier mobility is greater than 25 cm<sup>2</sup>/V s, and [[that]] the averaged transmittance of 400 to 1100 nm is greater than 80%.
- 9. (withdrawn) The oxide layer according to claim 8
  wherein the content of doping agent is less than 3 at-%,
  particularly less than 2.5 at-%.
- 10. (withdrawn) The oxide layer according to claim 8 wherein the resistivity is less than  $5*10^{-2}$  W cm.
- 1 11. (withdrawn) The oxide layer according to claim 8 wherein the charge carrier mobility is greater than 35 cm<sup>2</sup>/V s.

- 1 12. (withdrawn) The oxide layer according to claim 8 wherein the averaged transmittance of 400 to 1100 nm is greater than 82%.
- 1 13. (withdrawn) The oxide layer according to claim 8 wherein the layer comprises aluminum as the doping agent.
- 1 14. (withdrawn) Use of an oxide layer according to claim 8 in a solar cell.
- 15. (withdrawn) The use according to claim 14 in a crystalline silicon thin-film solar array.
- 1 16. (withdrawn) The use according to claim 14 in an amorphous and crystalline silicon tandem solar array.
- 17. (currently amended) The method according claim
  [[1]] 20 wherein a target with a doping content of less than 1 at-%
  is used.
- 1 18. (currently amended) The method according to claim [[1]] 20 wherein the substrate is heated to temperatures above 3 300 °C.

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- 19. (currently amended) The method according to claim
  [[1]] 20 wherein a dynamic deposition rate of greater than 100
  nm\*m/min is set that corresponds to a static deposition rate of
  greater than 380 nm/min.
- 20. (new) A method of making a conductive and
  transparent zinc-oxide layer on a substrate by reactive sputtering,
  the sputtering process including a hysteresis region, a heater for
  heating the substrate to more than 200 °C, and a dynamic deposition
  rate of greater than 50 nm\*m/min that responds to a static
  deposition rate of more than 190 nm/min, the method comprising the
  steps of:
- using a metallic Zn target with a doping content of less than 2.3 at-%;
  - controlling subsequent etching behavior and resulting surface roughness of the zinc-oxide layer by selecting a stabilized operating point within the unstable process region that is located between a transition point between a stable metal process and an unstable process and an inflection point of the stabilized process curve; and
  - post-treating the zinc-oxide layer by wet-chemical or dry etching to develop a root-mean-square roughness of 30 to 300nm.